Copper - ETP

Sheets



Material	Designation

ASTM C11000
JIS C1100
INDIAN Cu-ETP
EN CW004A
BS C101

Chemical Composition (%)

Cu 99.90

0.02 - 0.04

Applications

Electrical

Telecommunication

Architectural Antimicrobial

Switchgear

Specification

Thickness 0.3 - 4 mm Width 350 - 1000 mm Length 400 - 6000 mm

Temper O, 1/4H, 1/2H, 3/4H, H, EH, SH

Properties

Cold Workability Excellent
Electroplating Capacity Excellent
Soft Soldering Good
Corrosion Resistance Good

Description

Electrolytic-Tough-Pitch (ETP) is the most common copper with a minimum conductivity rating of 100% IACS and is required to be 99.9% pure. It has 0.02% to 0.04% oxygen content. It is produced by the direct conversion of selected refined cathodes and castings under carefully controlled conditions to prevent contamination of the pure oxygen-free metal during processing. It is universal for electrical applications.

Value Proposition

- Competitive Pricing
- Flexible LME price fixation
- Product Customization

- Quality Assurance
- Committed to deliveries
- Standard export pallet packing

This data is general technical specification; Binding technical specifications will be as per agreement.

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